

NIKO-SEM**Dual N-Channel Enhancement Mode
Field Effect Transistor****PE848DU**
PDFN 3.3x3.3S
Halogen-Free & Lead-Free**PRODUCT SUMMARY**

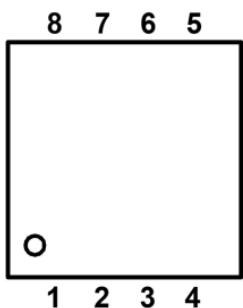
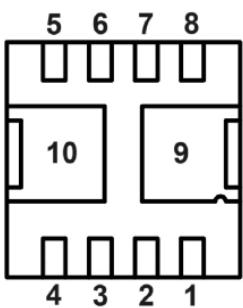
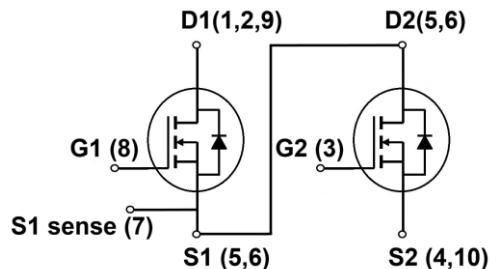
	$V_{(BR)DSS}$	$R_{DS(on)}$	I_D
Q2	30V	5.8mΩ	18A
Q1	30V	4.2mΩ	21A

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.
- 100% UIS and Rg Tested.

Applications

- Computing DC to DC converters.
- Communications DC to DC converters.
- General Purpose Point of load.

**Top****Bottom****PINNING INFORMATION**

PIN	SYMBOL	DESCRIPTION
1,2,9	D1	Drain 1
3	G2	Gate 2
4,10	S2	Source 2
5,6	D2 / S1	Drain 2 / Source 1
7	S1	Source sense 1
8	G1	Gate 1

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PARAMETERS/TEST CONDITIONS		SYMBOL	Q2	Q1	UNITS
Drain-Source Voltage		V_{DS}	30	30	V
Gate-Source Voltage		V_{GS}	± 12	± 12	V
Continuous Drain Current	$T_C = 25^\circ\text{C}$	I_D	50	50	A
	$T_C = 100^\circ\text{C}$		33	42	
Pulsed Drain Current ¹		I_{DM}	88	110	
Continuous Drain Current ³	$T_A = 25^\circ\text{C}$	I_D	18	21	W
	$T_A = 70^\circ\text{C}$		14	17	
Avalanche Current ⁴		I_{AS}	31	42	
Avalanche Energy ⁴		E_{AS}	14	26	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	27	33	W
	$T_C = 100^\circ\text{C}$		11	13	
Power Dissipation ³	$T_A = 25^\circ\text{C}$	P_D	3.1	3.4	W
	$T_A = 70^\circ\text{C}$		2	2.2	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS	
Junction-to-Ambient ²	$t \leq 10\text{s}$	$R_{\theta JA}$	Q2		40	
			Q1		36	
Junction-to-Ambient ²	Steady-State	$R_{\theta JA}$	Q2		66	
			Q1		63	
Junction-to-Case		$R_{\theta JC}$	Q2		4.5	
			Q1		3.8	

¹Pulse width limited by maximum junction temperature $T_{J(MAX)}=150^\circ\text{C}$.²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The value in any given application depends on the user's specific board design.³The Power dissipation is based on $R_{\theta JA} t \leq 10\text{s}$ value.⁴VDD=50V, L=0.03mH, Rg=25Ω.

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ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	Q2	30		V
		V _{GS} = 0V, I _D = 250μA	Q1	30		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	Q2	1.2	1.6	2.2
		V _{DS} = V _{GS} , I _D = 250μA	Q1	1.2	1.6	2.2
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±12V	Q2			±100
		V _{DS} = 0V, V _{GS} = ±12V	Q1			±100
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V	Q2		1	μA
		V _{DS} = 30V, V _{GS} = 0V	Q1		1	
		V _{DS} = 30V, V _{GS} = 0V, T _J = 55 °C	Q2		10	
		V _{DS} = 30V, V _{GS} = 0V, T _J = 55 °C	Q1		10	
Drain-Source On-State Resistance ⁵	R _{DS(ON)}	V _{GS} = 10V, I _D = 18A	Q2		4	5.8
		V _{GS} = 10V, I _D = 20A	Q1		2.9	4.2
		V _{GS} = 4.5V, I _D = 18A	Q2		5.8	7.8
		V _{GS} = 4.5V, I _D = 20A	Q1		4.1	5.7
Forward Transconductance ⁵	g _{fs}	V _{DS} = 5V, I _D = 18A	Q2		60	S
		V _{DS} = 5V, I _D = 20A	Q1		85	
DYNAMIC						
Input Capacitance	C _{iss}	Q2 V _{GS} = 0V, V _{DS} = 15V f = 1MHz Q1 V _{GS} = 0V, V _{DS} = 15V f = 1MHz	Q2		770	pF
Output Capacitance	C _{oss}		Q1		1216	
Reverse Transfer Capacitance	C _{rss}		Q2		208	
Gate Resistance	R _g		Q1		294	
Total Gate Charge ⁶	Q _g		Q2		42	
Gate-Source Charge ⁶	Q _{gs}		Q1		47	
Gate-Drain Charge ⁶	Q _{gd}	Q2 V _{DS} = 15V V _{GS} = 10V, I _D = 18A Q1 V _{DS} = 15V V _{GS} = 10V, I _D = 20A	Q2		1.1	Ω
			Q1		1.6	
			Q2		14	nC
			Q1		19.7	
			Q2		7.6	
			Q1		9.9	
			Q2		1.8	
			Q1		3.2	

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Turn-On Delay Time ⁶	$t_{d(on)}$	Q2 , $V_{DS} = 15V$ $I_D \approx 18A$ $V_{GS} = 10V$, $R_{GEN} = 6\Omega$	Q2	7.4		nS	
Rise Time ⁶	t_r		Q1	9.2			
Turn-Off Delay Time ⁶	$t_{d(off)}$		Q2	64			
Fall Time ⁶	t_f		Q1	70			
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)							
Continuous Current	I_S	$I_F = 18A$ $V_{GS} = 0V$	Q2		27	A	
Forward Voltage ⁵	V_{SD}		Q1		27		
Reverse Recovery Time	t_{rr}	$I_F = 20A$, $V_{GS} = 0V$	Q2		1	V	
		Q2 $I_F = 18A$ $dI_F/dt = 400A/\mu S$ Q1 $I_F = 20A$, $dI_F/dt = 400A/\mu S$	Q1		1.2		
Reverse Recovery Charge	Q_{rr}		Q2		12	nS	
			Q1		14		
			Q2		10	nC	
			Q1		17		

⁵Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.⁶Independent of operating temperature.

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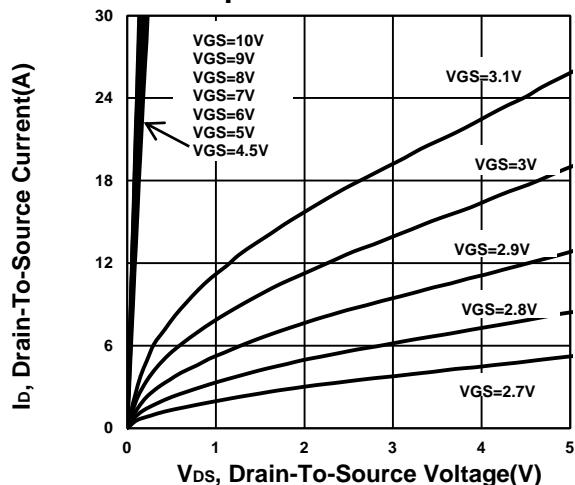
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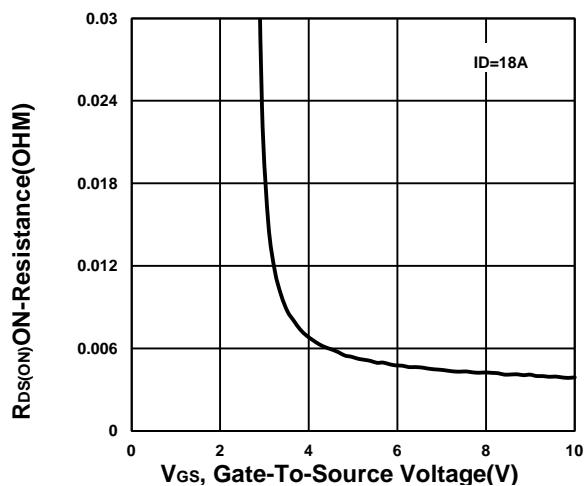
TYPICAL PERFORMANCE CHARACTERISTICS

Q2

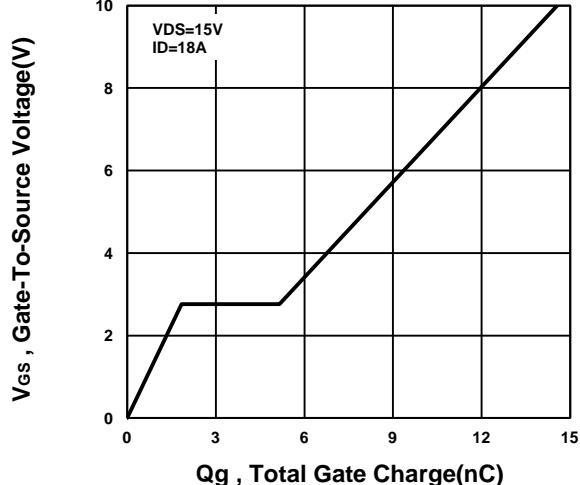
Output Characteristics



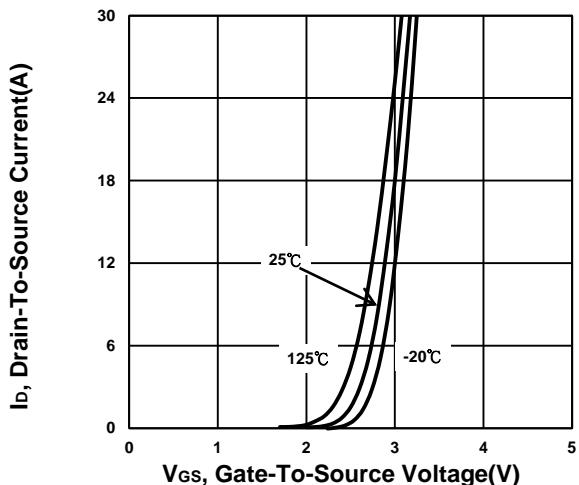
On-Resistance VS Gate-To-Source Voltage



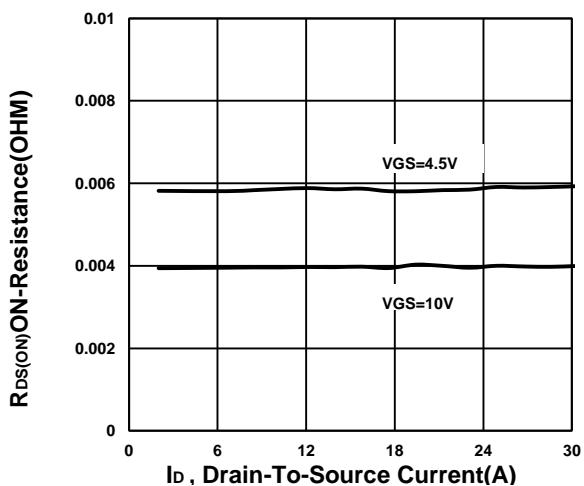
Gate charge Characteristics



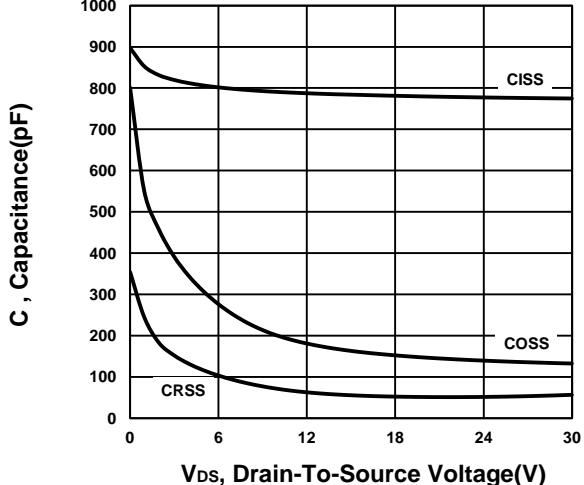
Transfer Characteristics

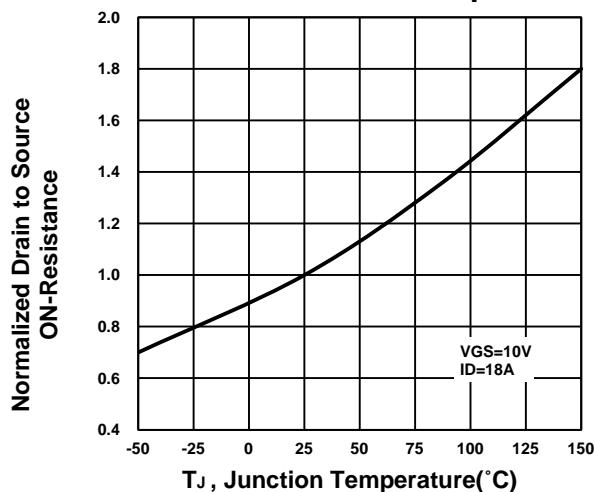
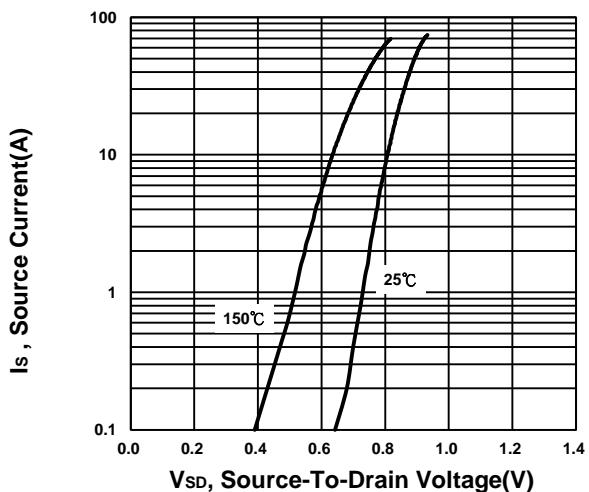
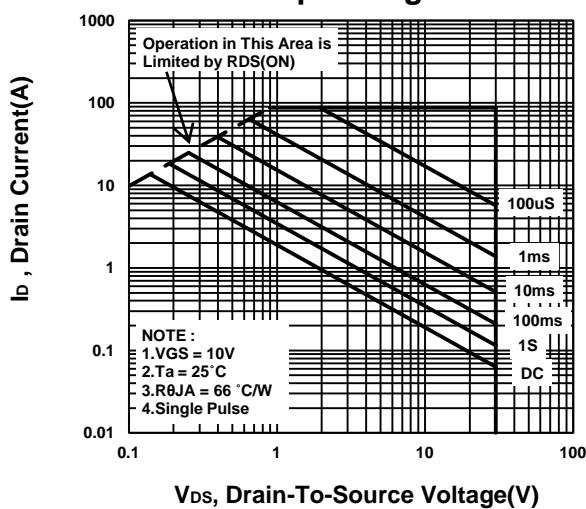
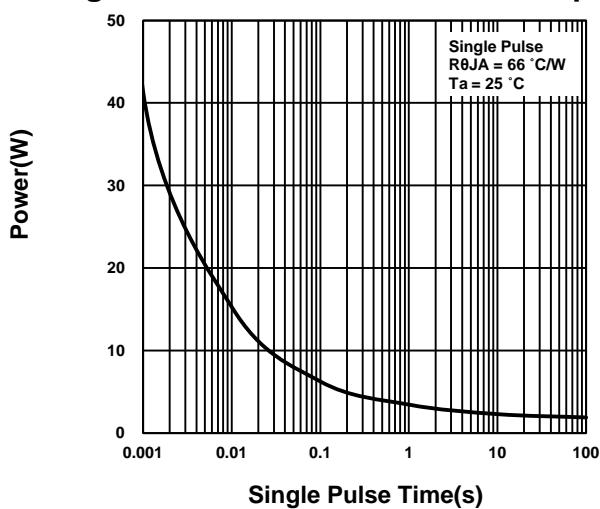
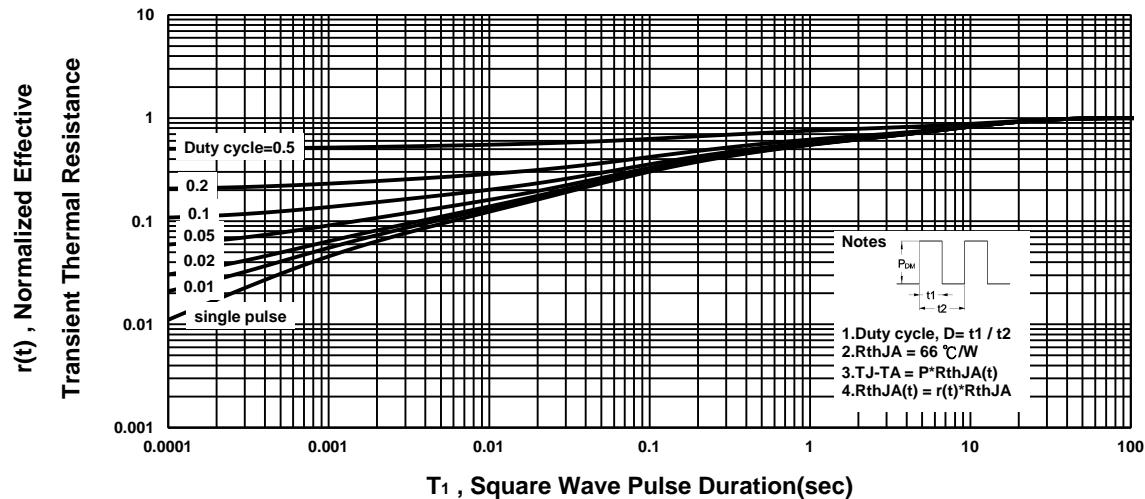


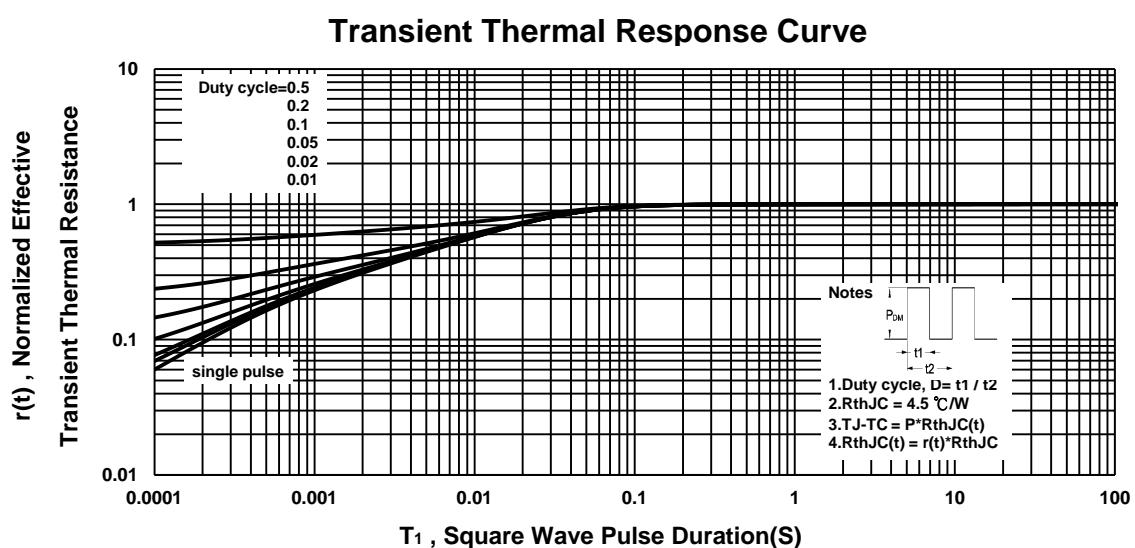
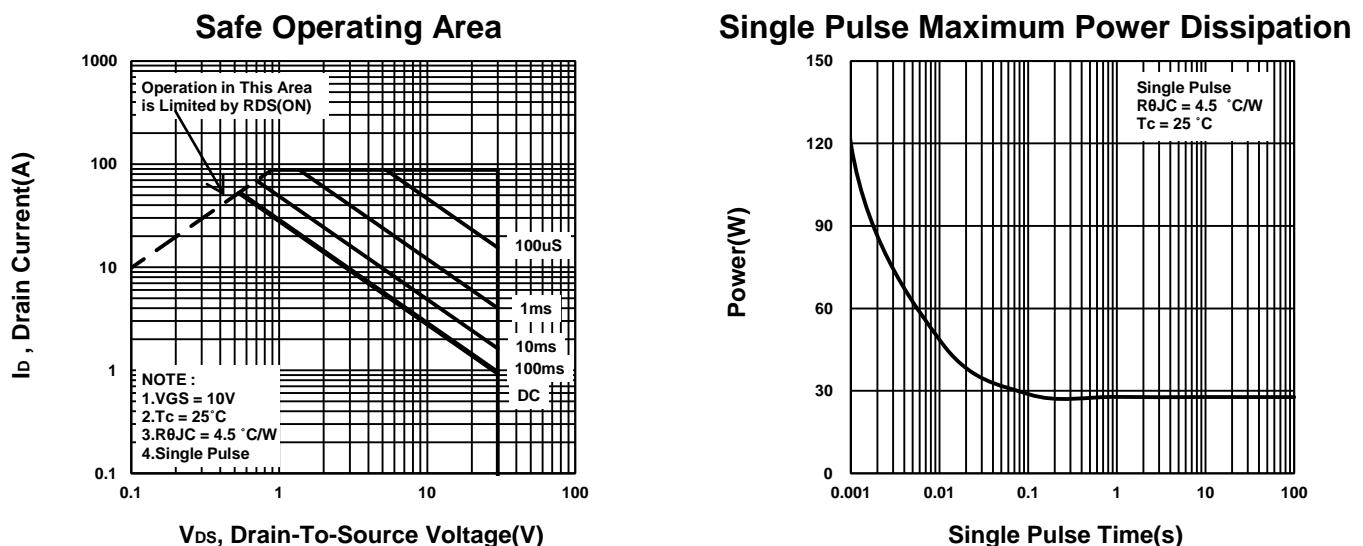
On-Resistance VS Drain Current



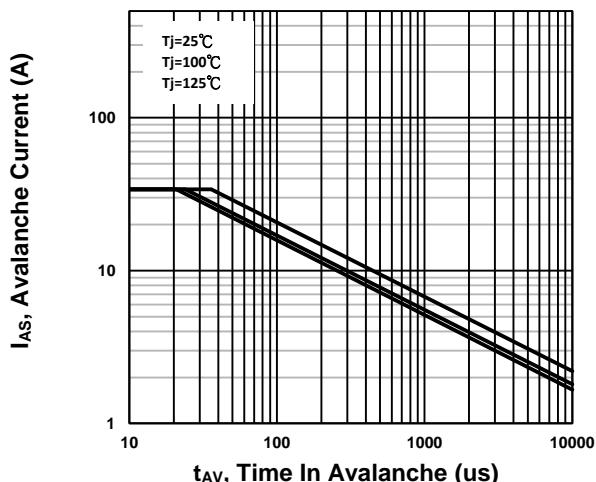
Capacitance Characteristic



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Halogen-Free & Lead-Free**On-Resistance VS Temperature****Source-Drain Diode Forward Voltage****Safe Operating Area****Single Pulse Maximum Power Dissipation****Transient Thermal Response Curve**

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Unclamped Inductive Switching Capability



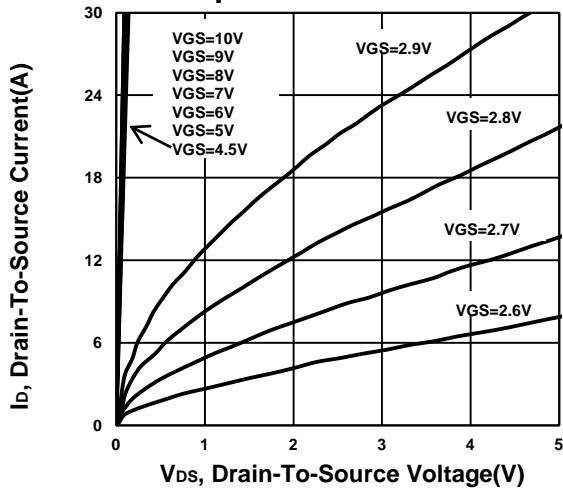
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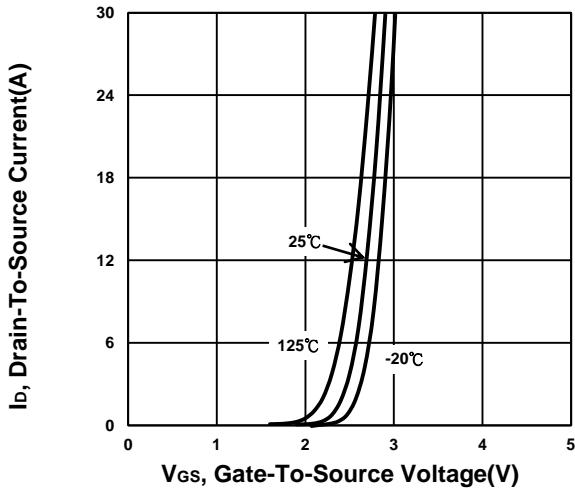
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Q1

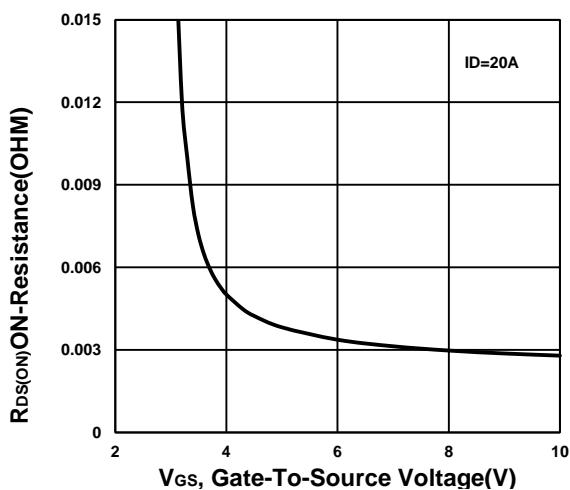
Output Characteristics



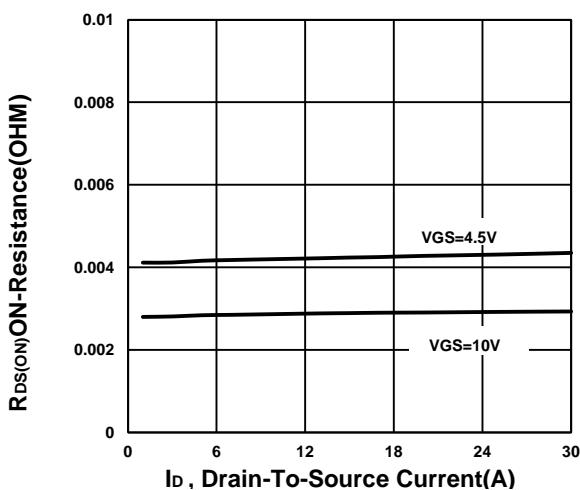
Transfer Characteristics



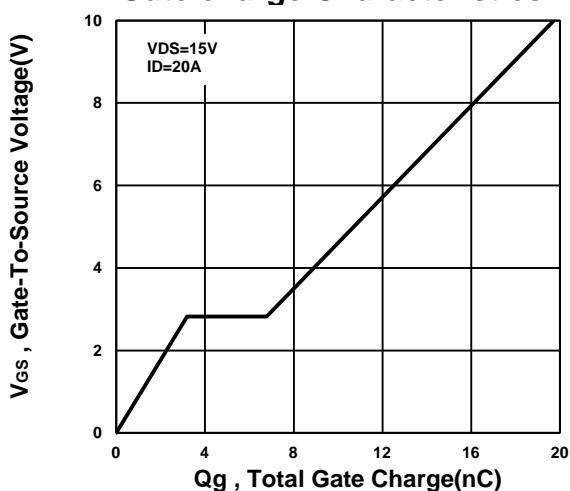
On-Resistance VS Gate-To-Source Voltage



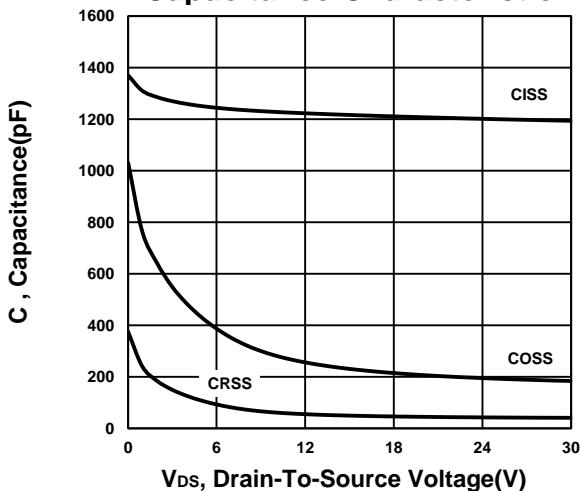
On-Resistance VS Drain Current

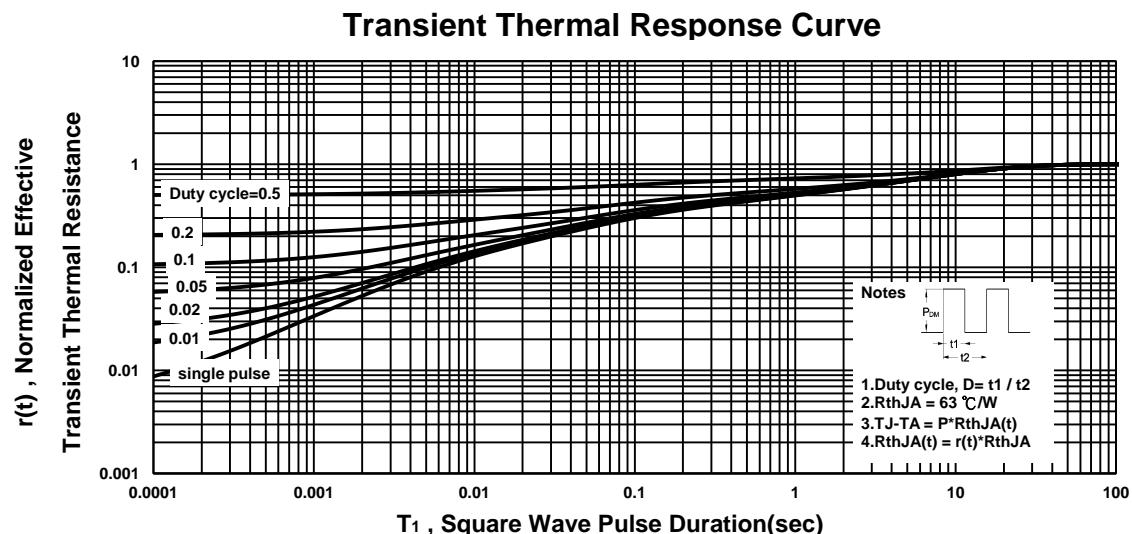
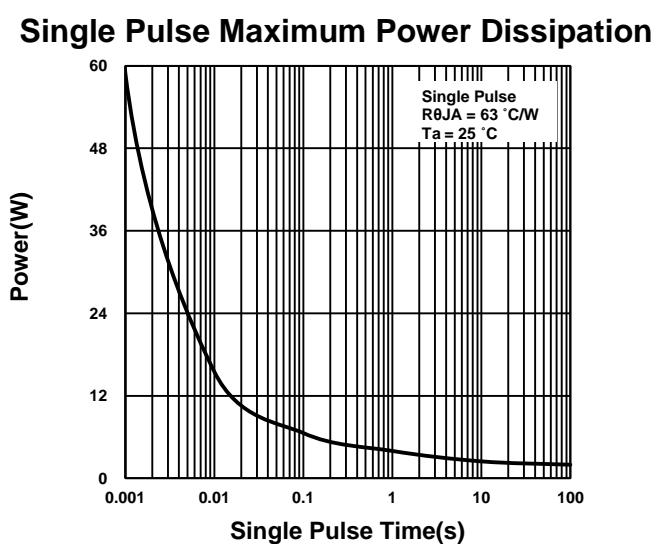
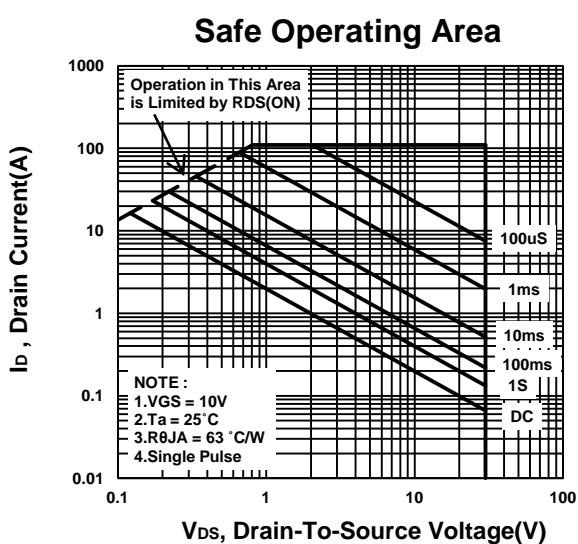
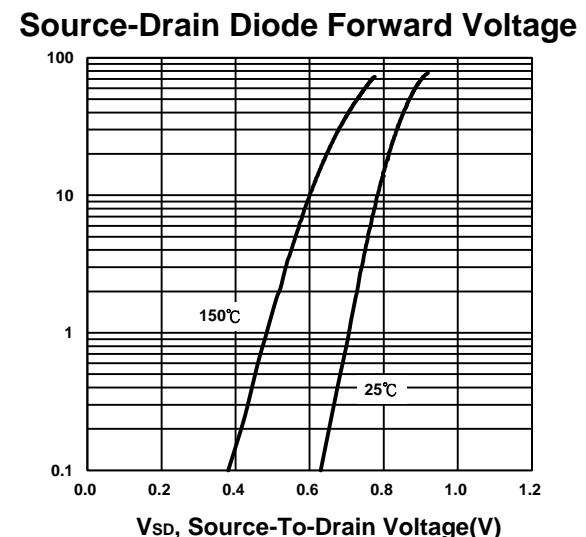
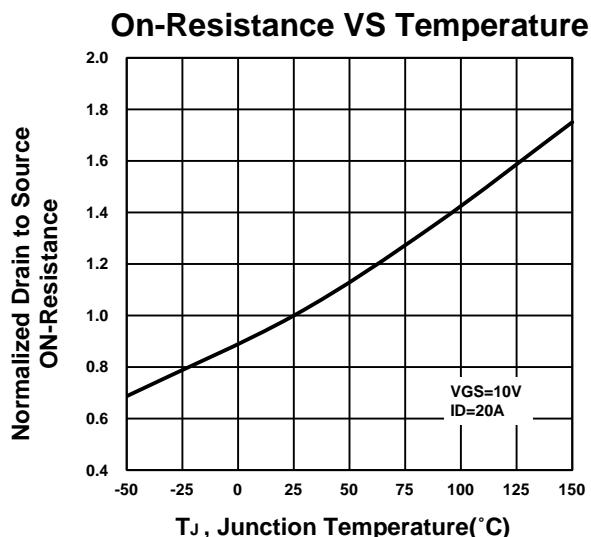


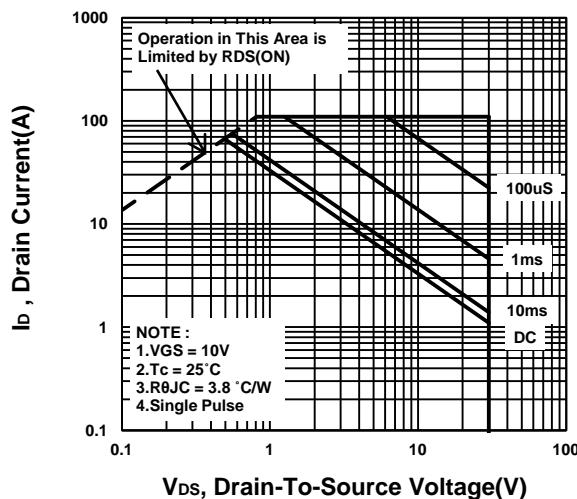
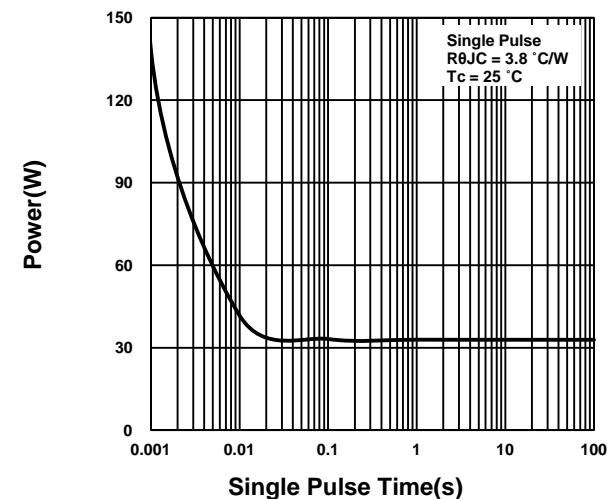
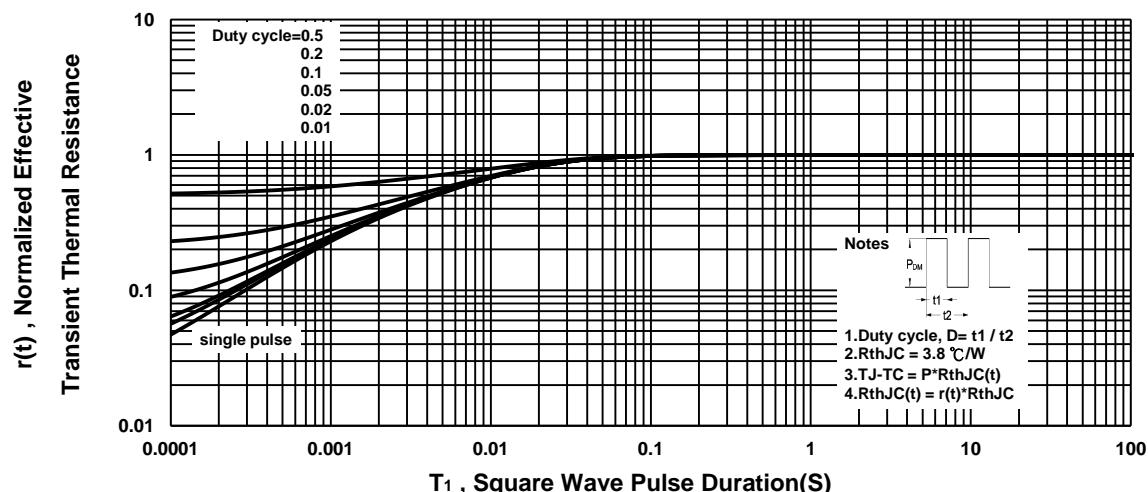
Gate charge Characteristics



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